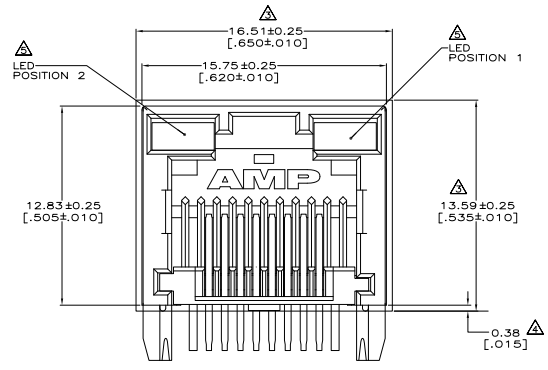
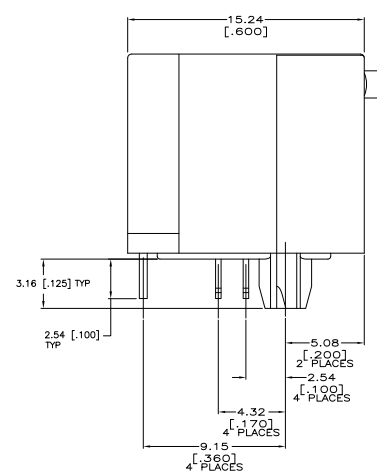
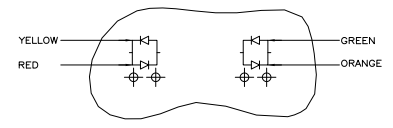
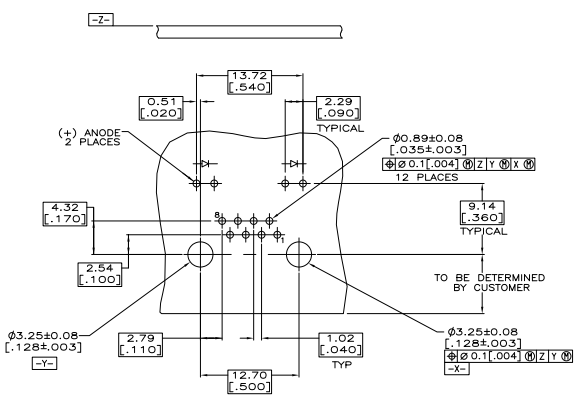
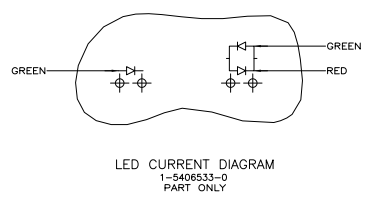
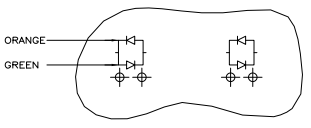


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REV	DATE	DESCRIPTION	BY	CHK	APP
AA	22				
		REVISED PER EDD-11-000033	25M011	RK	HMR



- ▲ MATERIAL:
 HOUSING - HIGH TEMPERATURE THERMOPLASTIC, BLACK, UL94V-0.
 TERMINALS - 0.36[.014] THICK PHOS BRONZE PLATED WITH 3.81µm[.000150] MINIMUM THICK MATTE TIN IN SOLDER AREA. 1.27µm [.000050] MINIMUM GOLD IN LOCALIZED PLATE AREA. ENTIRE TERMINAL PLATED WITH 1.27µm [.000050] MINIMUM THICK NICKEL.
 LIGHT EMITTING DIODE (LED) - DIFFUSED EPOXY LENS, 0.51 x 0.51[.020 x .020] CARBON STEEL WIREFRAME LEADS PREPLATED WITH 8.89 µm[.0003500] THICK Sn/Cu OVER 2.03 µm[.000080] THICK Ag OVER 1.02µm[.000040] THICK Cu OVER 3.56 µm[.000140] THICK Ni OVER 1.02µm[.000040] Cu UNDERPLATE
2. JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.
- ▲ SUGGESTED PANEL OPENING DIMENSIONS.
- ▲ SUGGESTED CLEARANCE BETWEEN BOTTOM OF CONNECTOR AND BOTTOM PANEL OPENING.
- ▲ SEE TABLE FOR COLOR OF LEADS AND NUMBER REQUIRED.
6. THIS MODULAR JACK WITH INTEGRATED LED IS NOT IR REFLOW SOLDERING PROCESS COMPATIBLE.
- ▲ OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI



OBSCLETE	TRAY	RED/YELLOW	ORANGE/GREEN	1-5406533-8
▲	TRAY	GREEN	RED/GREEN	1-5406533-7
▲	TRAY	GREEN	RED/GREEN	1-5406533-0
▲	TRAY	ORANGE/GREEN	YELLOW/GREEN	5406533-7
▲	TRAY	YELLOW	ORANGE/GREEN	5406533-6
▲	TRAY	GREEN	GREEN	5406533-5
▲	TRAY	YELLOW	GREEN	5406533-9
▲	TRAY	YELLOW	GREEN	5406533-2
▲	TRAY	YELLOW	GREEN	5406533-1
	PACKAGING	POSITION 2	POSITION 1	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT. SEE NOTE 1

INDICATOR COLOR

TE Connectivity

INVERTED MODULAR JACK ASSEMBLY, 1x1, LED

108-1163-4

114-2154

00779@5406533

CUSTOMER DRAWING